TE Internal #: 2-2013310-1

SO DIMM Sockets, Double Data Rate (DDR) 3, Stack Height .362 in [9.2 mm], Right Angle Module Orientation, Surface Mount, Cable-

to-Board, 204 Position

View on TE.com >



Connectors > Socket Connectors > Memory Sockets > SO DIMM Sockets











DRAM Type: Double Data Rate (DDR) 3

Stack Height: 9.2 mm [.362 in]

Module Orientation: Right Angle

PCB Mounting Style: Surface Mount

Connector System: Cable-to-Board

Features

Product Type Features

| DRAM Type | Double Data Rate (DDR) 3 |
|-----------------------------------|--------------------------|
| Connector System | Cable-to-Board |
| Sealable | No |
| Connector & Contact Terminates To | Printed Circuit Board |
| Product Type | Socket |

Configuration Features

| Number of Bays | 2 |
|---------------------|-------------|
| Center Key | Offset Left |
| Number of Keys | 1 |
| Module Orientation | Right Angle |
| Number of Positions | 204 |
| Number of Rows | 2 |
| Keying | Standard |

Electrical Characteristics



| DRAM Voltage | 1.5 V |
|---|--------------------------------|
| Signal Characteristics | |
| SGRAM Voltage | 1.5 V |
| Body Features | |
| Ejector Location | Both Ends |
| Latch Material | Stainless Steel |
| Latch Plating Material | Tin |
| Module Key Type | SGRAM |
| Ejector Type | Locking |
| Connector Profile | Standard |
| Contact Features | |
| Socket Style | SO DIMM |
| PCB Contact Termination Area Plating Material | Gold |
| Contact Base Material | Copper Alloy |
| Contact Mating Area Plating Material | Gold Flash |
| Contact Current Rating (Max) | .5 A |
| Socket Type | Memory Card |
| Termination Features | |
| Insertion Style | Cam-In |
| Mechanical Attachment | |
| PCB Mount Retention | With |
| PCB Mount Retention Type | Solder Peg |
| PCB Mounting Style | Surface Mount |
| Connector Mounting Type | Board Mount |
| Housing Features | |
| Centerline (Pitch) | .6 mm[.024 in] |
| Housing Color | Black |
| Housing Material | High Temperature Thermoplastic |
| Dimensions | |
| Stack Height | 9.2 mm[.362 in] |
| Row-to-Row Spacing | 8.2 mm[.322 in] |
| | |



| Operating Temperature Range | -55 – 85 °C[-67 – 185 °F] |
|-----------------------------|---------------------------|
| Operation/Application | |
| Circuit Application | Power |
| Industry Standards | |
| UL Flammability Rating | UL 94V-0 |
| Packaging Features | |
| Packaging Method | Emboss on Reel |
| Packaging Quantity | 150 |
| Other | |
| Comment | With floating peg. |

Product Compliance

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU | Compliant |
|---|---|
| EU ELV Directive 2000/53/EC | Compliant |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JUL 2021 (219) Candidate List Declared Against: JUL 2021 (219) Does not contain REACH SVHC |
| Halogen Content | Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free |
| Solder Process Capability | Reflow solder capable to 260°C |

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach



Compatible Parts



Customers Also Bought





TE Part #1888247-2 20 POS SMT CONN, SFP/SFP+, 15A



TE Part #2-2013022-1
EMBOSS TAPE DDR3 204P 4H STD









TE Part #2-2013289-1 EMBOSS TAPE DDR3 204P 5.2H STD



TE Part #1932258-1 Std USB 3.0, Type A, R/A, T/H,







Documents

Product Drawings
EMBOSS TAPE DDR3 204P 9.2H STD

English

CAD Files

Customer View Model ENG_CVM_CVM_2-2013310-1_C.2d_dxf.zip

English



3D PDF

3D

Customer View Model

ENG_CVM_CVM_2-2013310-1_C.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2-2013310-1_C.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

6-1773457-3_DDR3_DIMM_SOCKETS

Product Specifications

Product Specification

English

Product Environmental Compliance

MD_2-2013310-1_04152016554_dmtec

English

MD_2-2013310-1_04152016554_dmtec

English